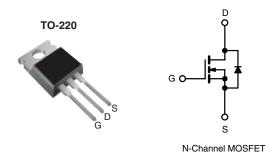


Power MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	60			
$R_{DS(on)}\left(\Omega\right)$	$V_{GS} = 5.0 \text{ V}$	0.10		
Q _g (Max.) (nC)	18			
Q _{gs} (nC)	4.5			
Q _{gd} (nC)	12			
Configuration	Single			



FEATURES

- Dynamic dV/dt Rating
- · Logic-Level Gate Drive
- R_{DS(on)} Specified at V_{GS} = 4 V and 5 V
- 175 °C Operating Temperature
- · Fast Switching
- · Ease of Paralleling
- · Simple Drive Requirements
- · Lead (Pb)-free Available

DESCRIPTION

Third generation Power MOSFETs from Vishay provides the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost effectiveness.

The TO-220 package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220 contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION	
Package	TO-220
Lead (Pb)-free	IRLZ24PbF
Lead (PD)-liee	SiHLZ24-E3
SnPb	IRLZ24
SILD	SiHLZ24

ABSOLUTE MAXIMUM RATINGS T	_C = 25 °C, ur	nless otherw	ise noted			
PARAMETER			SYMBOL	LIMIT	UNIT	
Gate-Source Voltage			V_{GS}	± 10	V	
Continuous Drain Current	\/ at F 0 \/	T _C = 25 °C	I _D	17	А	
	VGS at 5.0 V	$T_{C} = 25 ^{\circ}\text{C}$ $T_{C} = 100 ^{\circ}\text{C}$		12		
Pulsed Drain Current ^a			I _{DM}	68	1	
Linear Derating Factor				0.40	W/°C	
Single Pulse Avalanche Energy ^b			E _{AS}	110	mJ	
Maximum Power Dissipation	T _C = 25 °C		P_{D}	60	W	
Peak Diode Recovery dV/dt ^c			dV/dt	4.5	V/ns	
Operating Junction and Storage Temperature Range			T _J , T _{stg}	- 55 to + 175	00	
Soldering Recommendations (Peak Temperature)	for 10 s		-	300 ^d	- °C	
Mounting Torque	6-32 or M3 screw			10	lbf ⋅ in	
				1.1	N · m	

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. $V_{DD} = 25 \text{ V}$, starting $T_J = 25 \,^{\circ}\text{C}$, $L = 444 \,\mu\text{H}$, $R_G = 25 \,\Omega \,I_{AS} = 17 \,\text{A}$ (see fig. 12).
- c. $I_{SD} \le 17$ A, $dI/dt \le 140$ A/ μ s, $V_{DD} \le V_{DS}$, $T_J \le 175$ °C.
- d. 1.6 mm from case.

^{*} Pb containing terminations are not RoHS compliant, exemptions may apply



THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R _{thJA}	-	62		
Case-to-Sink, Flat, Greased Surface	R _{thCS}	0.50	-	°C/W	
Maximum Junction-to-Case (Drain)	R _{thJC}	-	2.5		

		wise noted		MIN.	I		T	
PARAMETER	SYMBOL	TEST	TEST CONDITIONS		TYP.	MAX.	UNIT	
Static				1		1		
Drain-Source Breakdown Voltage	V_{DS}	V _{GS} = 0	V, I _D = 250 μA	60	-	-	V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference t	o 25 °C, I _D = 1 mA	-	0.060	-	V/°C	
Gate-Source Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V$	_{GS} , I _D = 250 μA	1.0	-	2.0	V	
Gate-Source Leakage	I _{GSS}	V	$V_{GS} = \pm 10$		-	± 100	nA	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 6$	$V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}$		-	25	μΑ	
Zero date Voltage Brain Garrent		$V_{DS} = 48 \text{ V}, \text{ V}$	_{GS} = 0 V, T _J = 150 °C	-	-	250	μΑ	
Drain-Source On-State Resistance	Boo.	$V_{GS} = 5.0 \text{ V}$	I _D = 10 A ^b	-	-	0.10	Ω	
	R _{DS(on)}	V _{GS} = 4.0 V	$I_D = 8.5 A^b$	-	-	0.14	7.2	
Forward Transconductance	9fs	V _{DS} = 25 V, I _D = 10 A ^b		7.3	-	-	S	
Dynamic								
Input Capacitance	C _{iss}	$V_{GS} = 0 \text{ V},$ $V_{DS} = 25 \text{ V},$ $f = 1.0 \text{ MHz}, \text{ see fig. 5}$		-	870	-	pF	
Output Capacitance	C _{oss}			-	360	-		
Reverse Transfer Capacitance	C _{rss}			-	53	-		
Total Gate Charge	Qg			-	-	18	nC	
Gate-Source Charge	Q _{gs}	V _{GS} = 5.0 V	$I_D = 17 \text{ A}, V_{DS} = 48 \text{ V},$ see fig. 6 and 13 ^b	-	-	4.5		
Gate-Drain Charge	Q_{gd}		goo ngi o ana io	-	-	12		
Turn-On Delay Time	t _{d(on)}			-	11	-		
Rise Time	t _r	V_{DD} = 30 V, I_{D} = 17 A, R_{G} = 9.0 Ω , R_{D} = 1.7 Ω , see fig. 10 ^b		-	110	-	ns	
Turn-Off Delay Time	t _{d(off)}			-	23	-		
Fall Time	t _f			-	41	-		
Internal Drain Inductance	L _D	Between lead, 6 mm (0.25") fro	Between lead, 6 mm (0.25") from		4.5	-	- nH	
Internal Source Inductance	L _S	package and center of die contact		-	7.5	-		
Drain-Source Body Diode Characteristic	s	*			•			
Continuous Source-Drain Diode Current	Is	MOSFET symbol showing the integral reverse p - n junction diode		-	-	17	_	
Pulsed Diode Forward Current ^a	I _{SM}			-	-	68	A	
Body Diode Voltage	V_{SD}	$T_J = 25 ^{\circ}\text{C}, I_S = 17 \text{A}, V_{GS} = 0 \text{V}^{\text{b}}$		-	-	1.5	V	
Body Diode Reverse Recovery Time	t _{rr}	- T _J = 25 °C, I _F = 17 A, dl/dt = 100 A/μs ^b		-	110	260	ns	
Body Diode Reverse Recovery Charge	Q _{rr}			-	0.49	1.5	μC	
Forward Turn-On Time	t _{on}	Intrinsic turn	n-on is dor	minated b	v L _s and	L _D)		

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width $\leq 300~\mu s;$ duty cycle $\leq 2~\%.$



TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

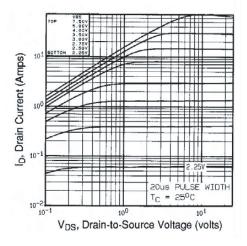


Fig. 1 - Typical Output Characteristics, $T_C = 25$ °C

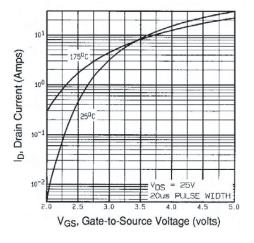


Fig. 3 - Typical Transfer Characteristics

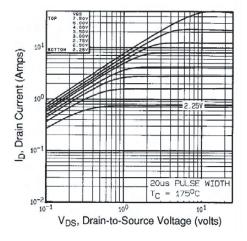


Fig. 2 - Typical Output Characteristics, T_C = 175 $^{\circ}C$

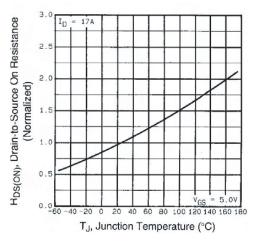


Fig. 4 - Normalized On-Resistance vs. Temperature



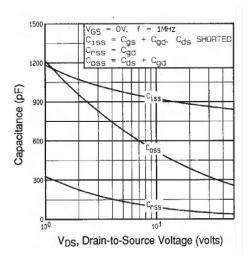


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

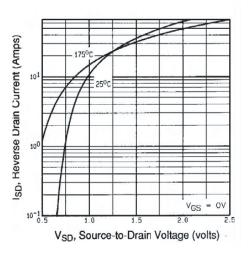


Fig. 7 - Typical Source-Drain Diode Forward Voltage

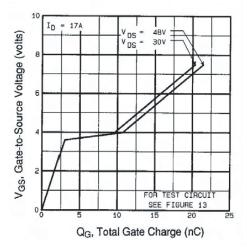


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

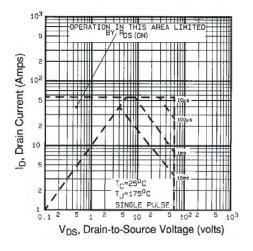


Fig. 8 - Maximum Safe Operating Area





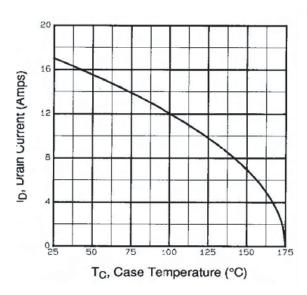


Fig. 9 - Maximum Drain Current vs. Case Temperature

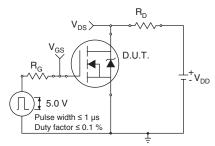


Fig. 10a - Switching Time Test Circuit

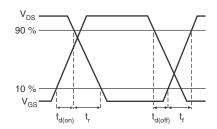


Fig. 10b - Switching Time Waveforms

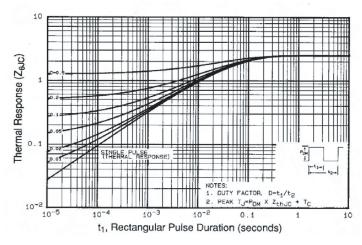


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

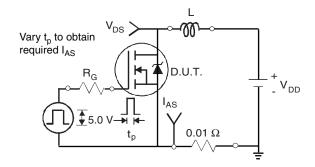


Fig. 12a - Unclamped Inductive Test Circuit

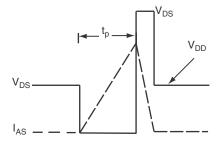


Fig. 12b - Unclamped Inductive Waveforms



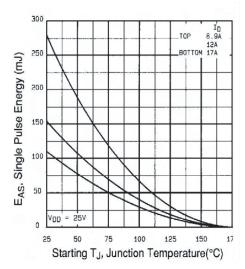


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

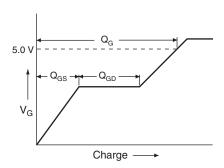


Fig. 13a - Basic Gate Charge Waveform

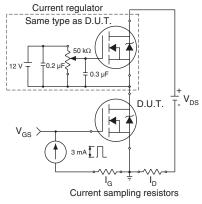
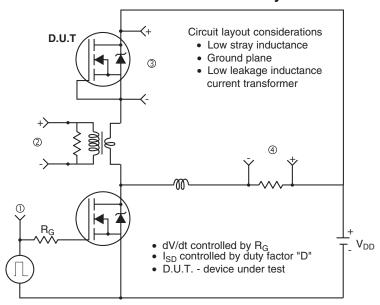
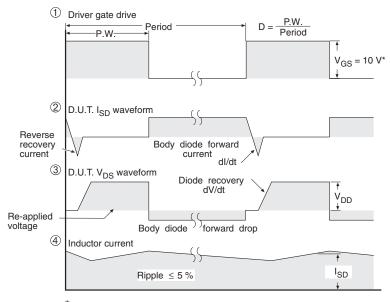


Fig. 13b - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit





* V_{GS} = 5 V for logic level devices and 3 V drive devices

Fig. 14 - For N-Channel

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